L Number	Hits	Search Text	DB	Time stamp
49	12	(micro near hinge) same (micro near machin$3 or "MEMS")	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 17:28
50	27	silicon same (hinge same (three near dimensional) or ("3 near D"))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 18:20
51	24	lin-chuang-chia.in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 18:21
52	12	lin-chuang-chia.in. and hinge	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 18:21
-	0	((open$3 or groove or hole) same silicon) same (hinge same (three near dimensional))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/07 12:46
-	1	((single near crystal) near3 silicon) same (hinge same (three near dimensional))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 18:10
-	6809	((single near crystal) near3 silicon) same etch$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/07 12:48
-	182	(((single near crystal) near3 silicon) same etch$3) same (micro near machin$3 or "MEMS")	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/07 12:49
-	61	((((single near crystal) near3 silicon) same etch$3) same (micro near machin$3 or "MEMS")) and @pd<20020107	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 17:20
-	0	(((((single near crystal) near3 silicon) same etch$3) same (micro near machin$3 or "MEMS")) and @pd<20020107) and (polysilicon near5 cap$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/07 13:07
-	0	(((((single near crystal) near3 silicon) same etch$3) same (micro near machin$3 or "MEMS")) and @pd<20020107) and (polysilicon same cap$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/07 13:07
-	24	(((((single near crystal) near3 silicon) same etch$3) same (micro near machin$3 or "MEMS")) and @pd<20020107) and (polysilicon same etch$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/07 13:08
-	7	(micro near hinge).clm.	USPAT; US-PGPUB	2003/09/11 17:37
-	157531	sensor.clm.	USPAT; US-PGPUB	2003/09/11 17:37
-	108	("MEMS" same sensor).clm.	USPAT; US-PGPUB	2003/09/11 17:38